





Phase 2 Power Supply and Mechanics

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Outline

- Phase 2 Power Supply Status
 - Design review
 - Noise measurement
 - Backplanes
- Phase 2 Mechanics Status
 - Design
 - AdvPhase1 problem
- System Test
- Production status

V2 PSU Design

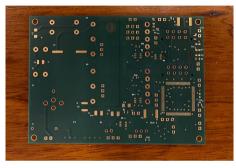


Features

Input

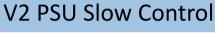
- 48V, Isolated GND
- Outputs with isolated GND from input
- 3.3V (20 A) for Digiopt12
- 5 V (20 A) for PACE
- 3.3V (0.7 A) for PACE Boot and SC FPGAs
- 2 V (5A) for DigiOpt12
- 4 Temperature sensors (T1..T4)

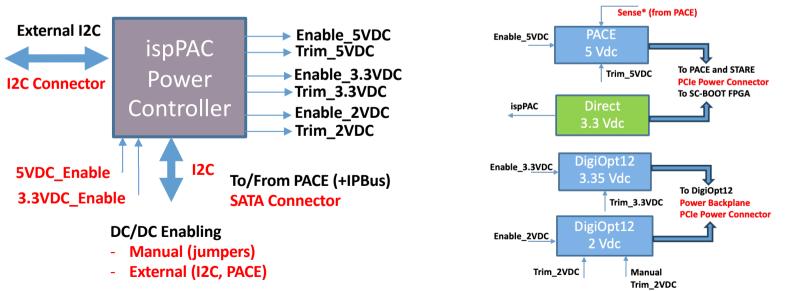
V2 PSU Dimensions



90 x 65 mm²

- 51% Area from Ph1 PSU



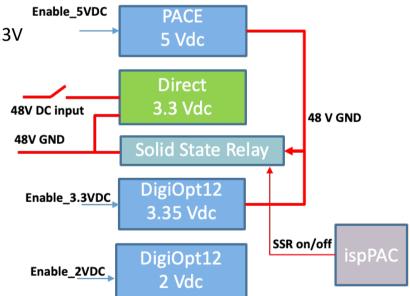




PSU V2 versions

Design modifications

- V2.4 (prototype t11)
- Include on/off switch
 - To handle 3.5 A max input current we need a big switch
 - Solution
 - Use a Solid State Relay to control GND connection
 - of the DC/DC converters
 - Use a small switch to switch on/off the Direct 3.3V DC/DC.
- Modify PCIe power connector to use commercially available cables
- <u>V2.5</u>
- Modify de 2V trace to increase current capacity.
- Include jumper to bypass the Solid State Relay for manual operation.
- Fix DC/DC drill diameters to fit different models

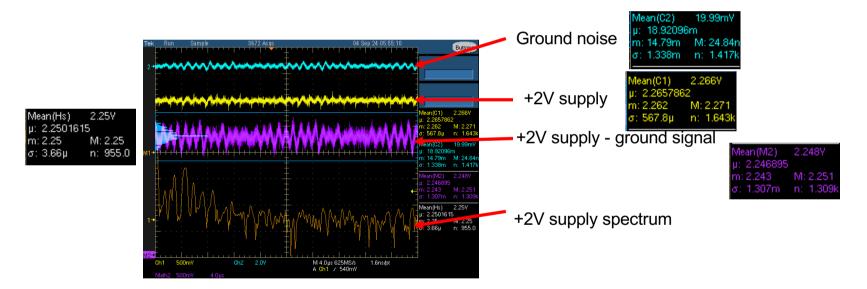


PSU +2V noise



PSU noise tests

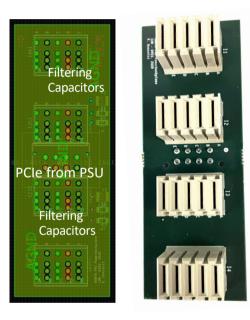
- Present DigiOpt12 ADC chips consume more on the 3.3V supply.
- New DigiOpt12 ADC chips consume more on the 2 V. Some concern about noise in that voltage
- First preliminary results as PACE system was not operative until first week of August.



Backplanes

POWER BACKPLANE

- Distributes +3.3V and +2V to DigiOpt12
- Capacitors for additional filtering



SIGNAL BACKPLANE

- Distributes to CLKs, SynPat, SPI, I2C to DigiOpt12
- FireFly connection to PACE
- Additional local I2C Access
 - Through I2C bridge
- SIGNAL BACKPLANE redesigns

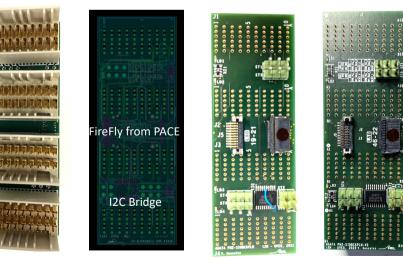
V2_t11

Missing Enable connection for i2C bridge Improved SILKSCREEN information

V2.4

Firefly connector wrong pinout affects DigiOpt12 SYNC_PATTERN & CLOCK signals V2.5 production

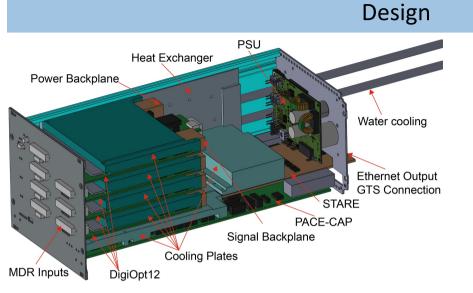
Firefly cable crosses signal pins. Corrected





Phase 2 Mechanics





- Cut out to place USB programmer



- Increase heat dissipation using side plates



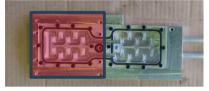
- Thermal Pads on top and bottom layers. Use bottom plate as heat spreader





Modifications to control temperature

- New Heat Exchanger for better cooling



 Fan in PACE cooling block to lower temperature around DC/DC converters. 70,000 hours lifetime.



- Fan at rear panel to lower PSU temp



Phase 2 Mechanics

Design



Front and rear panels

- Front panel



Plastic prototype



Aluminium prototype

- Rear panel



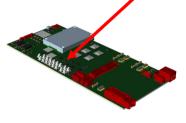
Plastic prototype

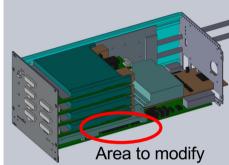


Aluminium prototype

Possible rework in the PACE cooling block to allow for a connection to an external trigger input.

Use these connectors for the trigger input





Hole for trigger connector

EGG.00.302.CLL





No panel mount available



AdvPhase 1 Mechanics

Corrosion problem



Recent failure in AdvPh1 electronics showed a corrosion problem in the heat exchangers

- Produces water leakage through holes in the exchangers
- Water analysed

| pН | Conductivity | Alkalinity | Anions (ppm) | | | | | | | | Cations (ppm) | | | | | | |
|------|--------------|--------------------------|--------------|----------|-------------------|----------|-------|-----------|-------------------|----------|---------------|--------|----------|-------|-----------|-----------|---------|
| | (µS/cm) | (mgCaCO ₃ /L) | Clorhides | Nitrites | N-NO ₂ | Nitrates | N-NO3 | Phosphate | P-PO ₄ | Sulphate | S-SO4 | Sodium | Ammonium | N-NH4 | Potassium | Magnesium | Calcium |
| 5.69 | 420 | 8.01 | 6.69 | 0.90 | 0.27 | 155.32 | 35.07 | 3.94 | 1.28 | 7.37 | 2.46 | 6.83 | 16.35 | 12.72 | 54.62 | 4.28 | 5.33 |

Conclusion

- High likelihood of promoting algae growth, due to the elevated levels of phosphates, nitrates, and ammonium.
- The ammonium ions can react with aluminium forming aluminium complexes that could potentially accelerate the corrosion rate.
- Algae can contribute forming more acidic biofilms on the surface of aluminium that can lead to pitting corrosion.
- The presence of copper salts produce galvanic corrosion promoting dissolution of the aluminium also leading to pitting corrosion.
- Solution
 - Apply an Alodine treatment to the heat exchanger serpentine (33 modules)
 - Use particular cooling system for electronics.
- Prevention: don't leave water inside exchangers if it's not flowing.





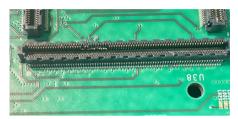
System test

Thermal tests

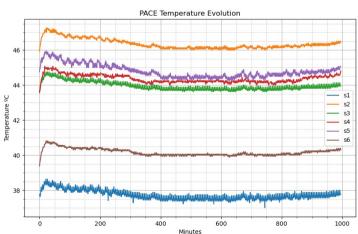


Tests with box closed

- Faced several issues with PACE operation
 - SOM PLL stopped
 - SOM connector replacement
 - SD card reader not working



- Finally, PACE system up and sending data to server through optical fiber (only one link) with the help of Javier during August.
- Temp sensors monitoring in PACE through ipBus.
- Vcc =48 V, Icc = 1.833A



Run test for ~16 hours

Yesterday at 11pm after running for 4 days

```
|PACE| PACE_SC_temp
48: 39.44 °C (S1)
49: 48.06 °C (S2)
4A: 45.44 °C (S3)
4C: 48.13 °C (S4)
4D: 46.81 °C (S5)
4E: 42.63 °C (S6)
```

Production status

For 50 units



PCB

- Power backplane: 52 units
- Signal backplane: 60 units
- PSU: final design ready. Waiting in case noise results imply design modification

Component procurement

- Power backplane: ok
- Signal backplane: ok
- PSU: ok

Mechanics

- Boxes: for 51 units
- Crates: for 51 units
- Cooling plates + heat exchangers:
 - 12 PACE cooling blocks
 - 66 STARE cooling blocks
 - 204 Digitopt12 cooling blocks
 - 59 Heat exchanger + 9 with older design to modify
 - 2 Frontal panels
 - 1 Rear panel

Cables

- Firefly: ok
- PCIe: commercial, to be procured
- SATA: commercial, to be procured





Thank you for your attention